

NITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Confirmation No. 6334

Koji MISHIMA et al.

Attorney Docket No. 2003 1305

Serial No. 10/660,483

Group Art Unit 1742

Filed September 12, 2003

Examiner William T. Leader

METHOD AND APPARATUS FOR PLATING SUBSTRATE WITH COPPER

Mail Stop: Amendment

REPLY TO NOTICE OF NON-COMPLIANT AMENDMENT

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

Please find attached an Amendment After Final in response to the Notice of Non-Compliant Amendment dated February 13, 2007. The attached Amendment After Final is identical to the Amendment After Final submitted on December 21, 2006, with the only exception being that the inserted paragraph listed on page 2 is not underlined.

THE CUMMISSIONER IS AUTHORIZED TO CHARGE ANY DEFICIENCY IN THE FEES FOR THIS PAPER TO DEPOSIT ACCOUNT NO. 23-0975 Respectfully submitted,

Koji MISHIMA et

W. Douglas Hahm

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AMENDMENT AFTER FINAL

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Responsive to the Office Action dated September 22, 2006, please amend the above-identified application as follows.

THE COMMISSIONER IS AUTHORIZED TO CHARGE ANY DEFICIENCY IN THE FEES FOR THIS PAPER TO DEPOSIT ACCOUNT NO. 23-0975